

2-25-02

A  
PATENT

Docket No. 5853-223

## PATENT APPLICATION TRANSMITTAL LETTER

Commissioner for Patents  
**BOX PATENT APPLICATION**  
 Washington, DC 20231

J1050 U.S. PTO  
10/08/1979  
02/22/02

Transmitted herewith for filing of the patent application of:

Inventor(s): Rajiv K. Singh  
 Seung-Mahn Lee

for **IMPROVED CHEMICAL-MECHANICAL POLISHING SLURRY FOR POLISHING OF COPPER OR SILVER FILMS**

are the following:

Specification, including Abstract  
 16 Sheets of drawing (3 sets)  
 Executed Declaration and Power of Attorney  
 Assignment with Recordation Cover Sheet  
 Other: 2 postcards

## CLAIMS AS FILED

FOR	NO. FILED	NO. EXTRA
Basic Fee		
Total Claims	45	25
Indep Claims	8	5
multiple dependent claim present	No	

If the difference in Col. 1 is less than zero, enter "0" in Col. 2

Assignment Recordation

## Small Entity

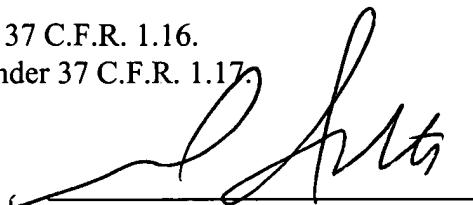
RATE	FEE
	\$370.00
x \$ 9 =	\$ 225.00
x \$ 42 =	\$ 210.00
x \$135 =	\$
<b>TOTAL</b>	<b>\$ 805.00</b>
	\$ 40.00

## Other than a Small Entity

RATE	FEE
	\$ 740.00
x \$ 18 =	\$
x \$ 84 =	\$
x \$270 =	\$
<b>TOTAL</b>	<b>\$</b>

You are hereby authorized to charge \$845.00 to Deposit Account No. 50-0951.  
 The Commissioner is hereby authorized to charge any underpayment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-0951.  
 A duplicate of this sheet is enclosed.  
 Any additional filing fees required under 37 C.F.R. 1.16.  
 Any patent application processing fees under 37 C.F.R. 1.17.

02/22/02  
Date

  
 Neil R. Jetter  
 Registration No. 46,803